

Multilayer Ceramic Chip Inductors

MHI0603D Series, 0603 Size

Features:

- Excellent Q factor and SRF characteristics
- Small size of 1005/1608 is suitable for small portable devices
- Supports operating frequency up to 6GHz with nominal inductance values from 1.0nH to 470nH.

Product Identification:

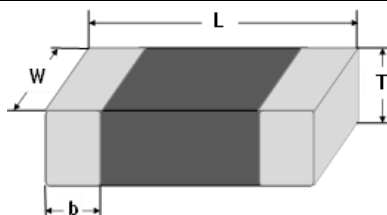
MHI 0603 D 10N J T

(1) (2) (3) (4) (5) (6)

- (1) **Series Code:** Multilayer ceramic chip inductor
- (2) **Size Code:** L x W (inch), the first two digits - L (length), the last two digits - W (width)
- (3) **Characteristic Code**
- (4) **Inductance Code:** 10N - 10nH
- (5) **Tolerance Code:** J = $\pm 5\%$; K = $\pm 10\%$; S = $\pm 0.3\text{nH}$
- (6) **Package Code:** T - Tape & Reel

Shape and Dimensions:

Unit (mm)	0603
L	1.6 ± 0.15
W	0.8 ± 0.15
T	0.8 ± 0.15
b	0.3 ± 0.20



Applications:

- RF resonance and impedance matching circuit
- RF and wireless communication
- Information technology equipment, computers, telecommunications, radar detectors, automotive electronics, cellular phones, pagers, PDAs, keyless remote systems
- L-C filter configurations

Packaging:

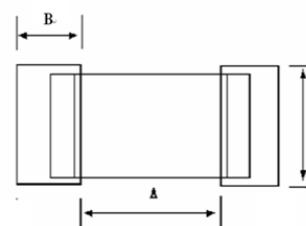
Chip Size	Parts on 7 inch (178mm) Reel
0603	4,000

Operating Temperature Range:

- -55 to +125°C (including self-temperature rise)

Recommended Land Pattern:

Unit (mm)	0603
A	0.70~0.80
B	0.55~0.60
C	0.80~0.90



Multilayer Ceramic Chip Inductors

MHI0603D Series, 0603 Size

Ordering Information:

Part Number	Inductance (nH)	L Test Frequency	Q Min. @ 100MHz	SRF typ. (MHz)	RDC Max. (Ω)	IDC ¹ Max. (mA)	Tolerance
MHI0603D10NJT	10	100 MHz, 200 mV	12	3,000	0.26	600	5/10
MHI0603D12NJT	12	100 MHz, 200 mV	12	2,600	0.28	600	5/10
MHI0603D15NJT	15	100 MHz, 200 mV	12	2,500	0.32	600	5/10
MHI0603D18NJT	18	100 MHz, 200 mV	12	2,400	0.35	600	5/10
MHI0603D1N0ST	1.0	100 MHz, 200 mV	8	10,000	0.10	600	±0.3nH
MHI0603D1N5ST	1.5	100 MHz, 200 mV	8	8,000	0.10	600	±0.3nH
MHI0603D1N8ST	1.8	100 MHz, 200 mV	8	8,000	0.10	600	±0.3nH
MHI0603D22NJT	22	100 MHz, 200 mV	12	2,000	0.40	500	5/10
MHI0603D27NJT	27	100 MHz, 200 mV	12	1,900	0.45	500	5/10
MHI0603D2N2ST	2.2	100 MHz, 200 mV	8	7,200	0.10	600	±0.3nH
MHI0603D2N7ST	2.7	100 MHz, 200 mV	10	6,200	0.10	600	±0.3nH
MHI0603D33NJT	33	100 MHz, 200 mV	12	1,600	0.55	400	5/10
MHI0603D39NJT	39	100 MHz, 200 mV	12	1,400	0.60	400	5/10
MHI0603D3N3ST	3.3	100 MHz, 200 mV	10	5,200	0.12	600	±0.3nH/10
MHI0603D3N9ST	3.9	100 MHz, 200 mV	10	5,000	0.14	600	±0.3nH/10
MHI0603D47NJT	47	100 MHz, 200 mV	12	1,300	0.70	400	5/10
MHI0603D4N7ST	4.7	100 MHz, 200 mV	10	4,750	0.16	600	±0.3nH/10
MHI0603D56NJT	56	100 MHz, 200 mV	12	1,100	0.75	400	5/10
MHI0603D5N6ST	5.6	100 MHz, 200 mV	10	4,100	0.18	600	±0.3nH/10
MHI0603D68NJT	68	100 MHz, 200 mV	12	1,050	0.85	400	5/10
MHI0603D6N8ST	6.8	100 MHz, 200 mV	10	3,750	0.22	600	5/10
MHI0603D82NJT	82	100 MHz, 200 mV	12	900	1.00	300	5/10
MHI0603D8N2ST	8.2	100 MHz, 200 mV	10	3,300	0.24	600	5/10
MHI0603DR10JT	100	100 MHz, 200 mV	12	770	1.20	300	5/10
MHI0603DR12JT	120	100 MHz, 200 mV	8	650	1.30	300	5/10
MHI0603DR15JT	150	100 MHz, 200 mV	8	2,400	1.70	250	5/10
MHI0603DR18JT	180	100 MHz, 200 mV	8	2,400	1.90	250	5/10
MHI0603DR22JT	220	100 MHz, 200 mV	8	2,000	2.00	250	5/10

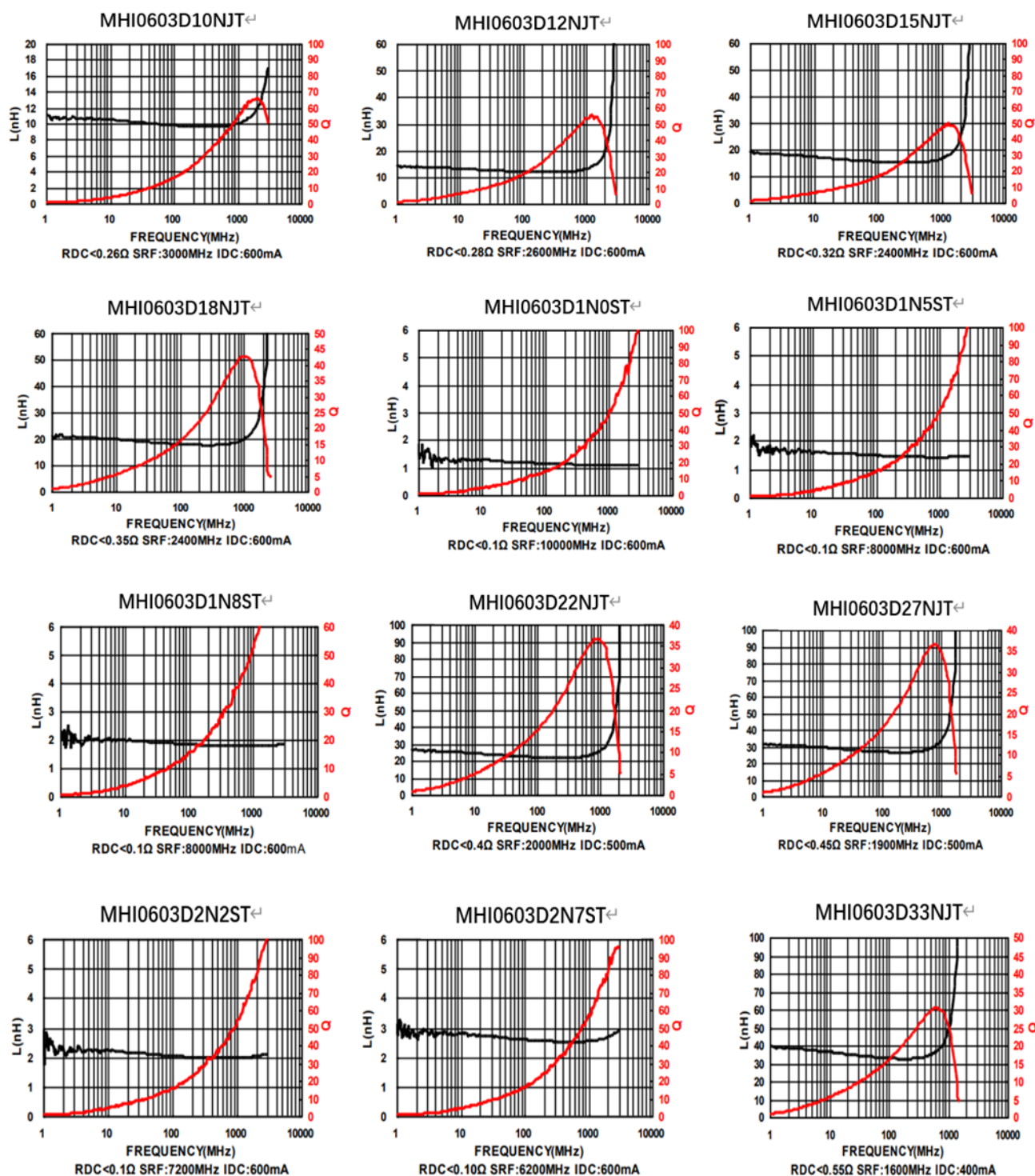
¹ IDC: Applied the current to coils, the inductance shall be less than 10% initial value.

Multilayer Ceramic Chip Inductors

MHI0603D Series, 0603 Size

High Frequency Characteristics:

Test Instruments : Agilent E4991A Material/Impedance Analyzer

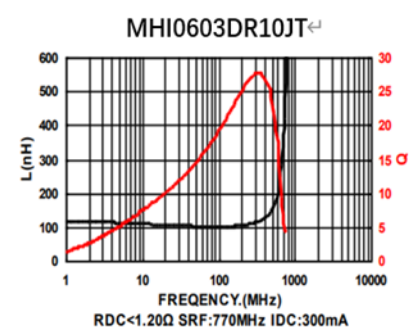
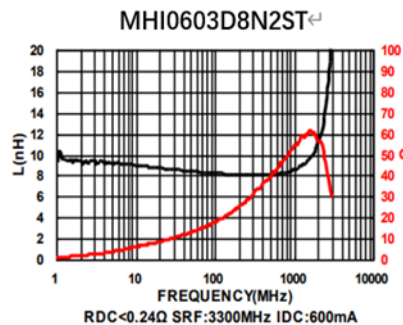
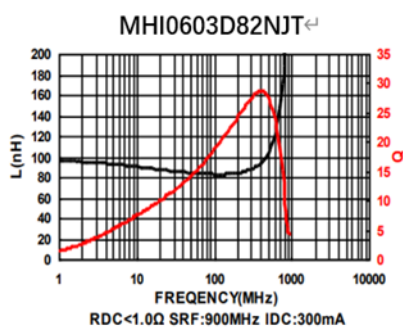
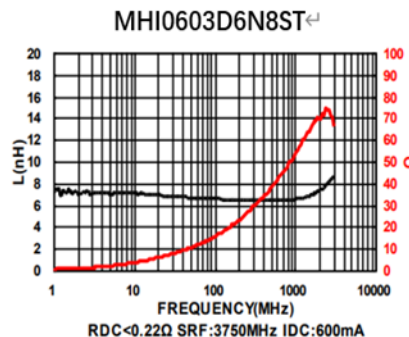
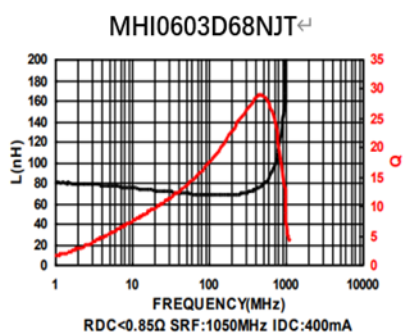
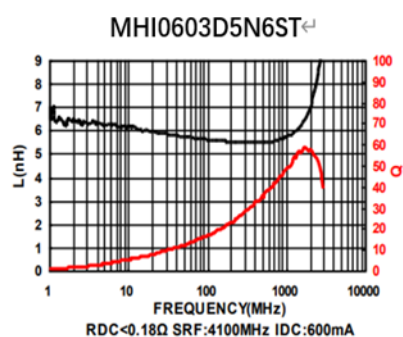
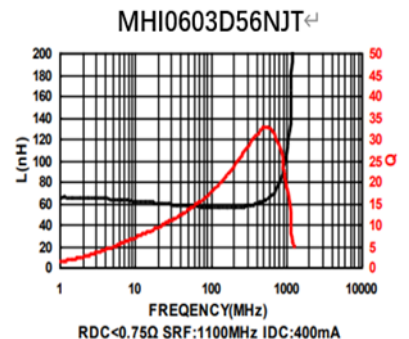
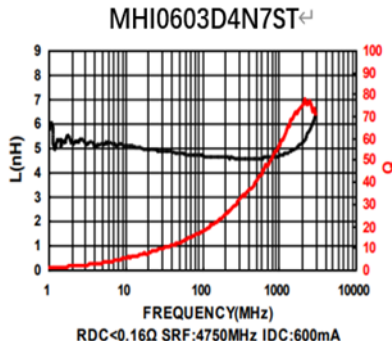
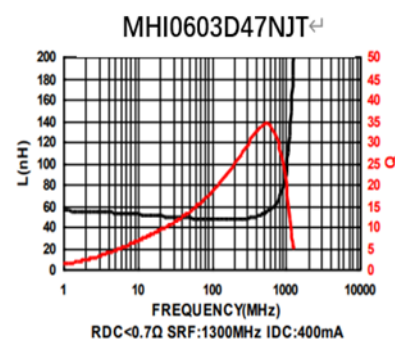
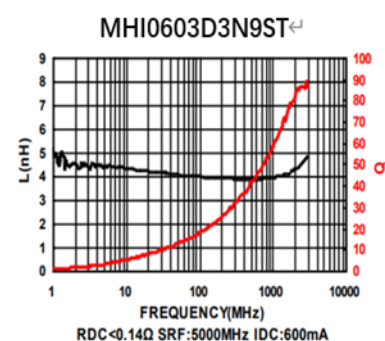
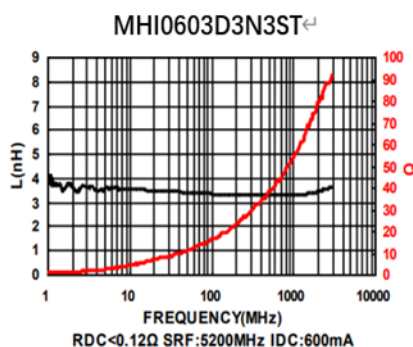
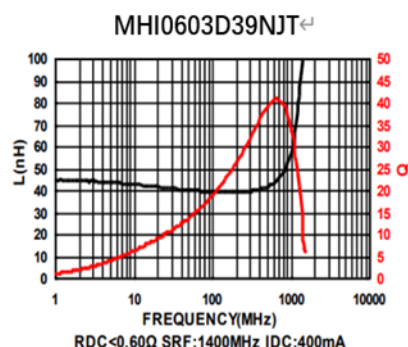


Multilayer Ceramic Chip Inductors

MHI0603D Series, 0603 Size

High Frequency Characteristics:

Test Instruments : Agilent E4991A Material/Impedance Analyzer

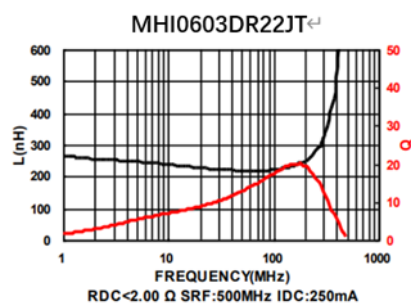
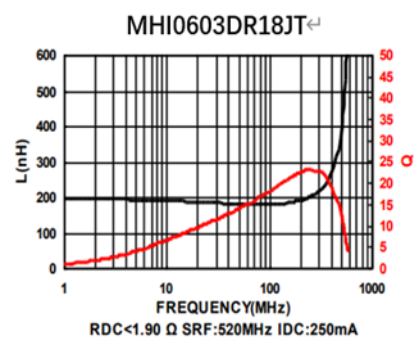
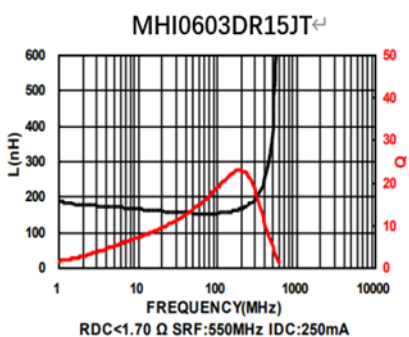
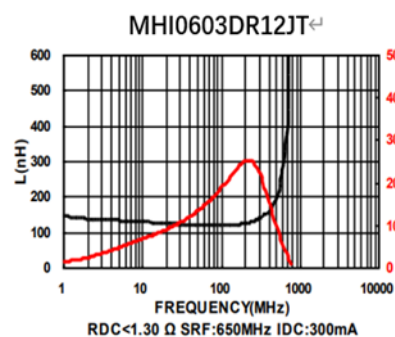


Multilayer Ceramic Chip Inductors

MHI0603D Series, 0603 Size

High Frequency Characteristics:

Test Instruments : Agilent E4991A Material/Impedance Analyzer

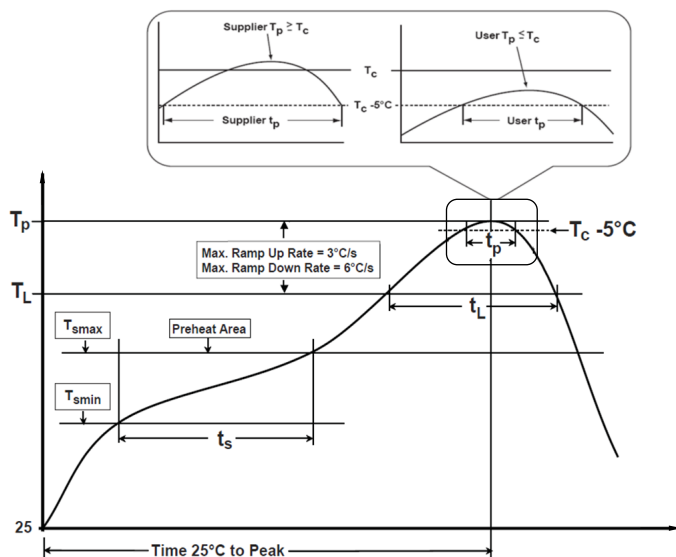


Multilayer Ceramic Chip Inductors

MHI0603D Series, 0603 Size

Recommended Temperature Profile:

* Recommended Temperature Profile for Reflow Soldering



Profile Feature	Pb-Free Assembly
Preheat/Soak Temperature Min (T_{smin}) Temperature Max (T_{smax}) Time (t_s) from (T_{smin} to T_{smax})	150°C 200°C 60~180 seconds
Ramp-up rate (T_L to T_p)	3°C/second max.
Liquidous temperature (T_L) Time (t_L) maintained above T_L	217°C 60~150 seconds
Peak package body temperature (T_p)	260°C
Time (t_p)*within 5°C of the specified classification temperature (T_c)	30 seconds *
Ramp-down rate (T_p to T_L)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.
* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum	

Do not use this product in any Automotive Power train or Safety equipment such as ECU, ABS systems, or Battery Pack, Battery Management System, Battery Charger for Electric Vehicles and Plug-in Hybrid Vehicles. Only AEM products clearly described as "for Automotive Use" on its catalog can be used for automobile applications such as Power train and Safety equipment.

Disclaimer

Specifications are subject to change without notice. AEM products are designed for specific applications and should not be used for any purpose (including, without limitation, automotive, aerospace, medical, life-saving applications, or any other application which requires especially high reliability for the prevention of such defect as may directly cause damage to the third party's life, body or property) not expressly set forth in applicable AEM product documentation. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Warranties granted by AEM shall be deemed void for products used for any purpose not expressly set forth in applicable AEM product documentation. AEM shall not be liable for any claims or damages arising out of products used in applications not expressly intended by AEM as set forth in applicable AEM product documentation. The sale and use of AEM products is subject to AEM terms and conditions of sale. Please refer to AEM's website for updated catalog and terms and conditions of sale.



AEM Components (Suzhou) Co., Ltd

**461 Zhongnan Street,
China-Singapore Suzhou Industrial Park
Jiangsu, P. R. China, 215026**

Tel: 86-512-6258-0028

Fax: 86-512-6258-0018

Email: marketing@aemchina.com

AEM Components (USA), Inc.

6670 Cobra Way, San Diego, CA 92121, USA

Tel: 1-858-750-6100

Fax: 1-858-481-1123

Email: sales@aemcomponents.com